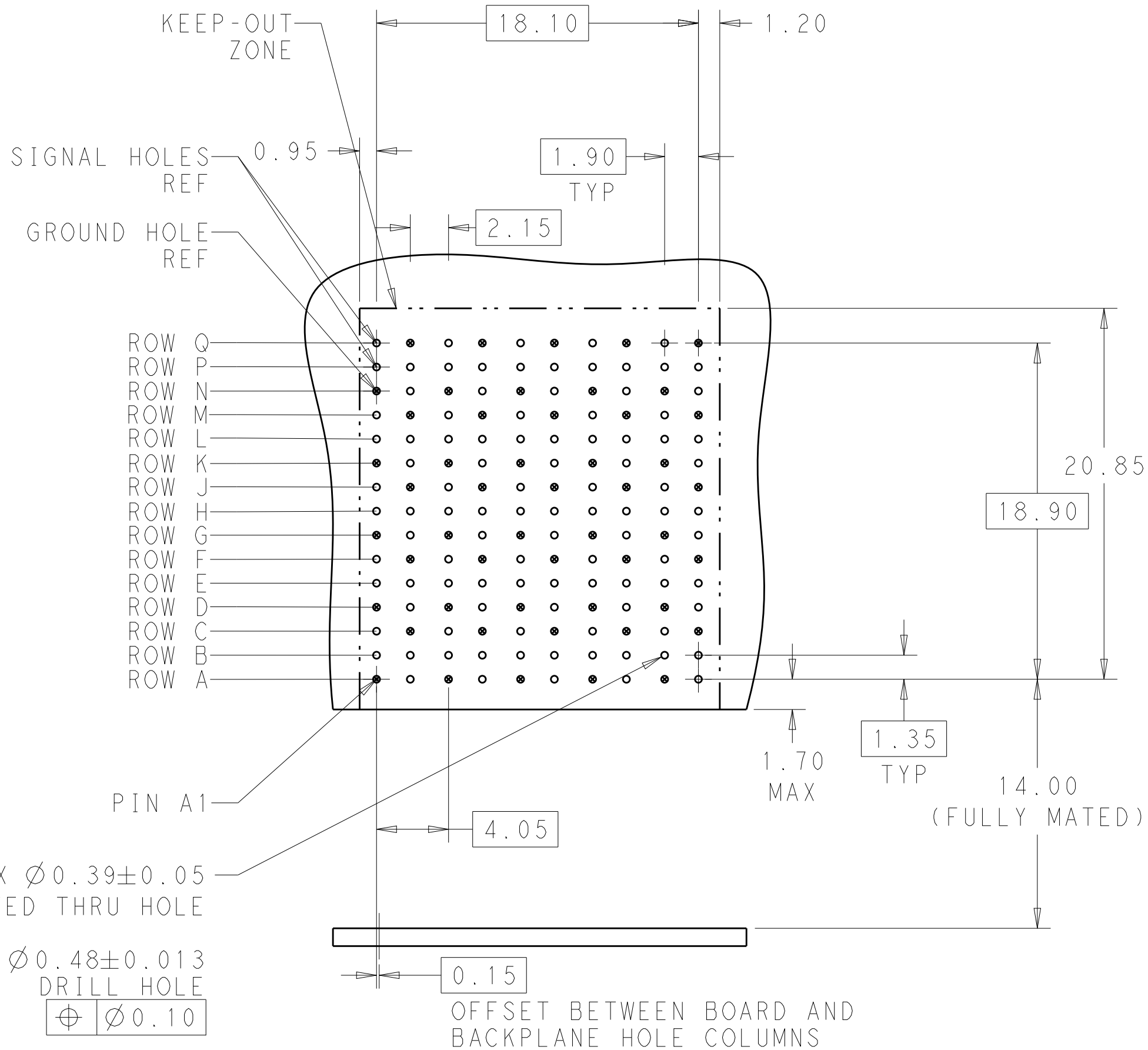
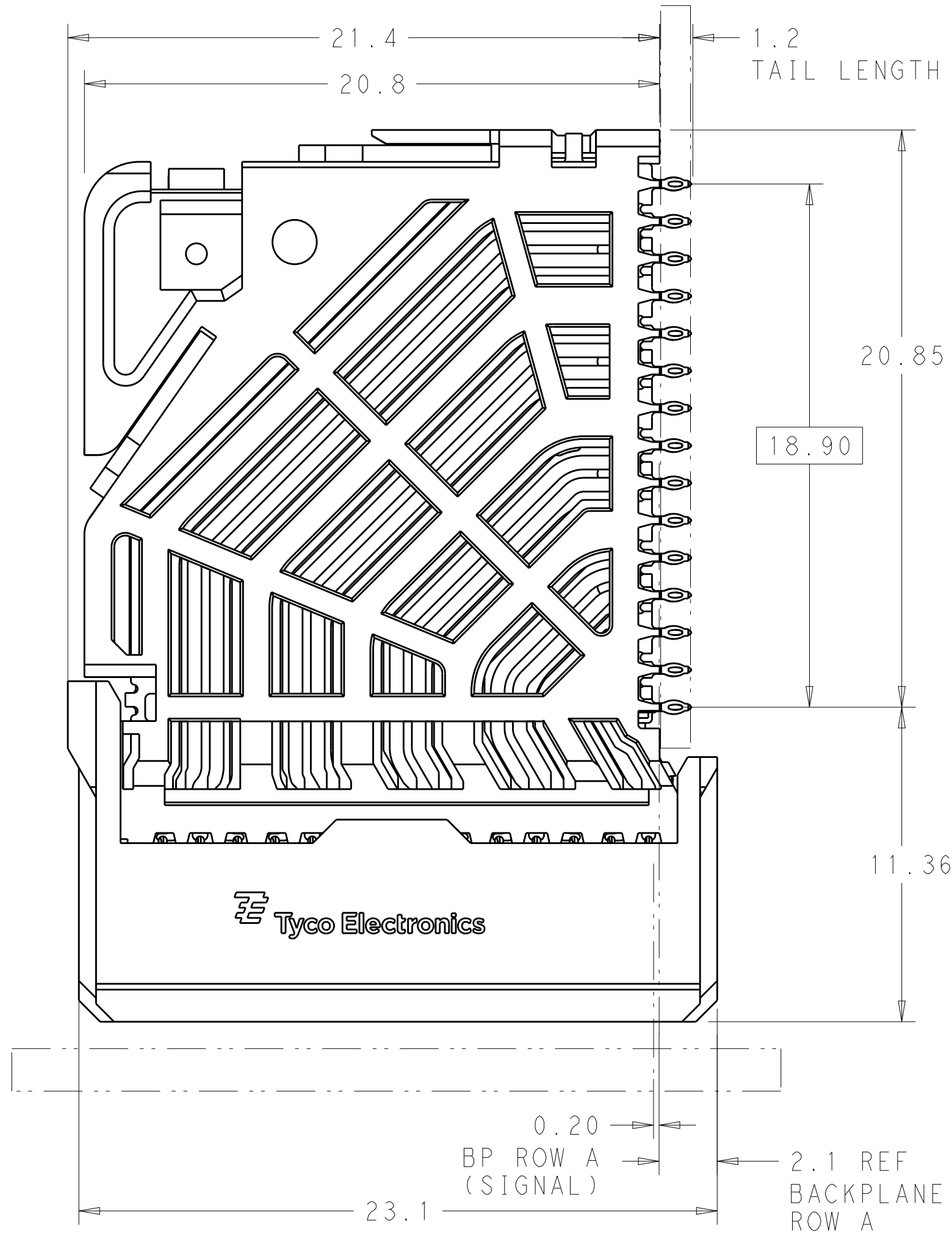
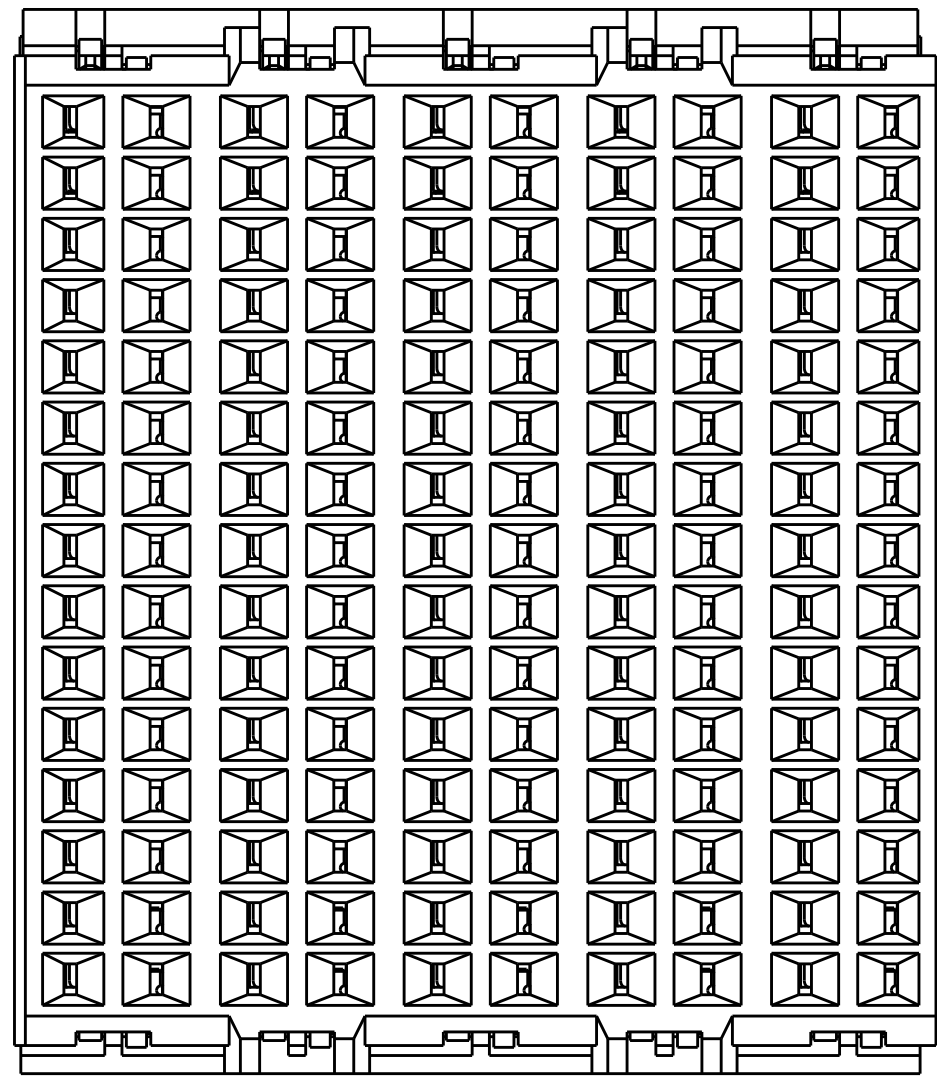
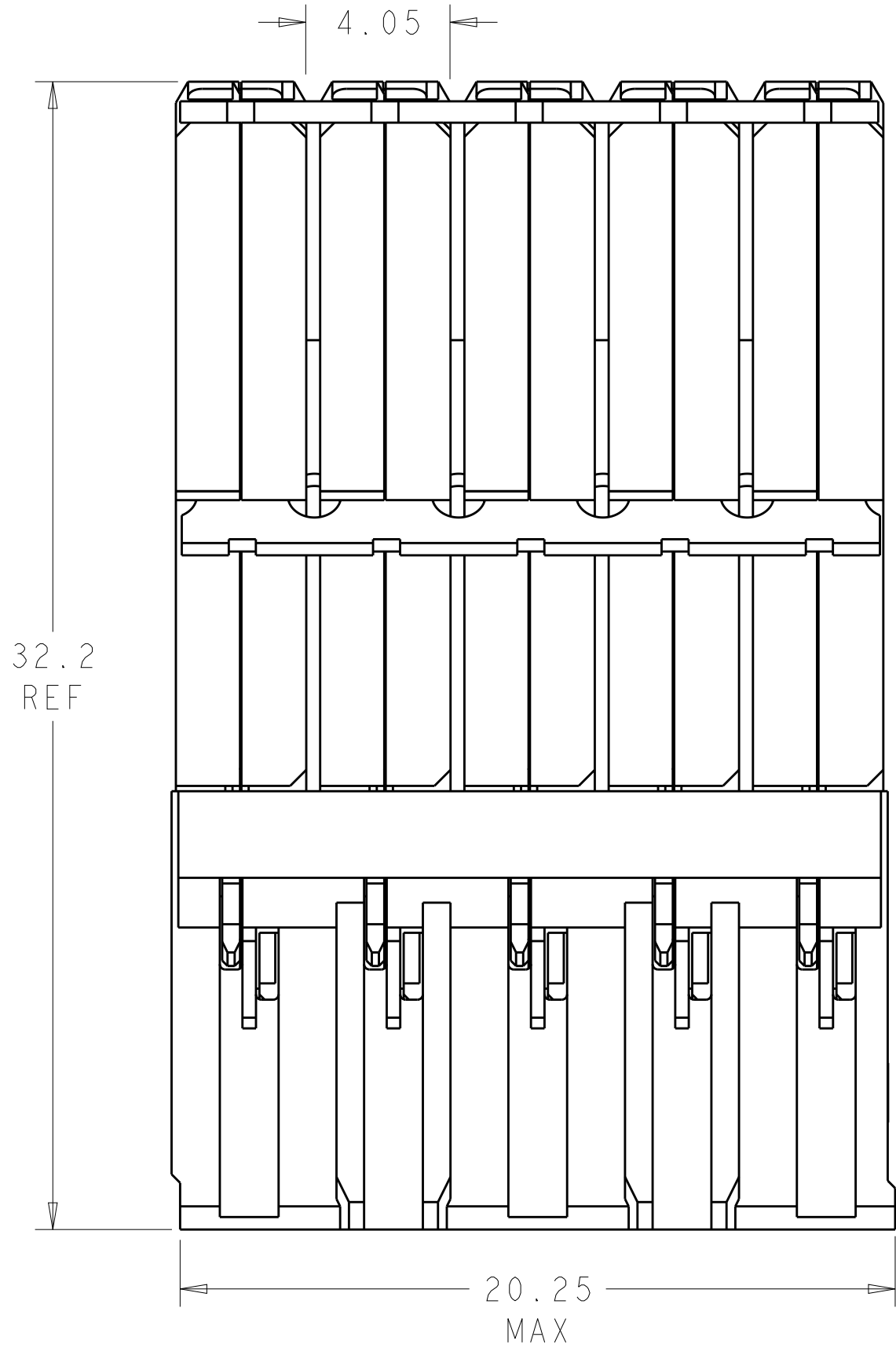


D

C

B

A



150X $\varnothing 0.39 \pm 0.05$ PLATED THRU HOLE

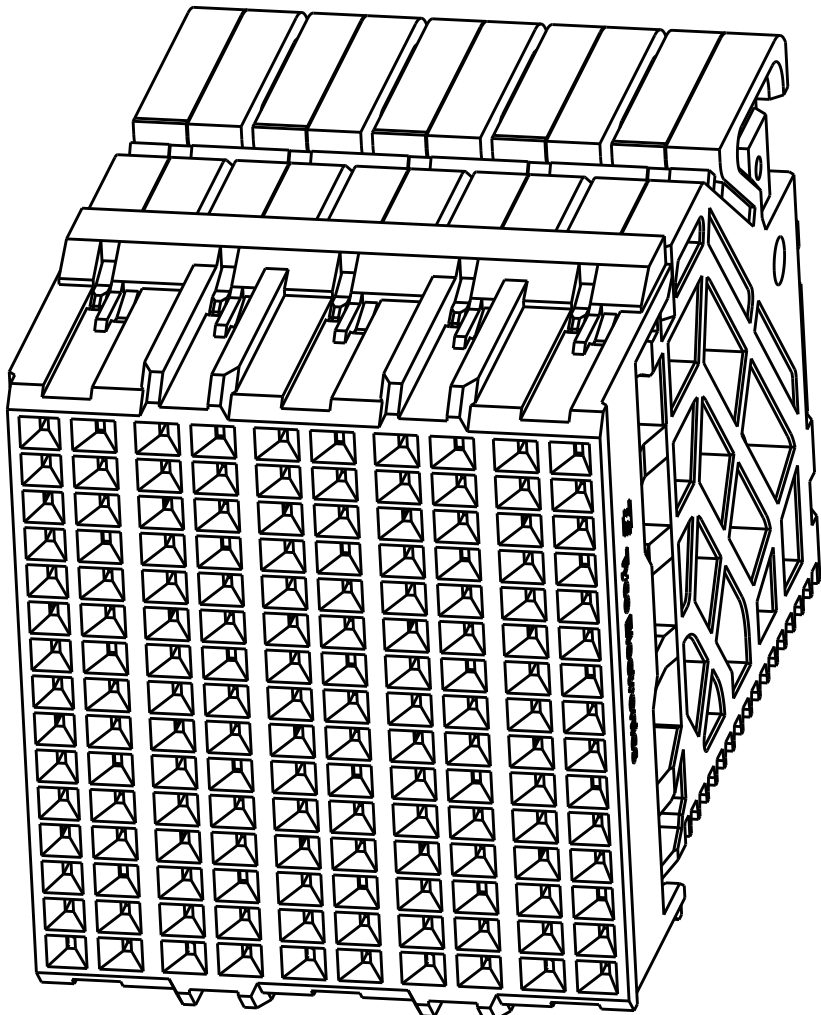
150X $\varnothing 0.48 \pm 0.013$ DRILL HOLE

$\varnothing 0.10$

RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

LOC		DIST		REVISONS			
AD	00	P	LYR	DESCRIPTION	DATE	DWN	APVD
		D		REVISED PER ECO-15-004915	10APR2015	AP	DD

- 1 MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
- 2 FINISH:
30 μ " SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.



SCALE 4:1

REFER TO WWW.TE.COM
FOR PRODUCT AVAILABILITY

NONE	2	2132695-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.			DWN 29APR2011		 TE Connectivity	
DIMENSIONS:			CHK D. DIXON 29APR2011			
mm		TOLERANCES, UNLESS OTHERWISE SPECIFIED:		APVD D. DIXON 29APR2011		NAME IMPACT, ORTHOGONAL, 5 PAIR, DAUGHTERCARD, 10 COLUMN, NO GUIDE, SIGNAL MODULE, 0.39 EYELET